









PRODUCT DATASHEET



- ► PLCC4 SMD Top View
- ➤ 3528 1.85t
- ► Red (630nm) / Yellow (570nm)

NOD18S09



PLCC4 3528 1.85t





Package: PLCC4 Top View SMT White Package

Forward Current: 20/20mA* Forward Voltage (typ.): 2.0/2.0V

Luminous Intensity (typ.): 220/200mcd@20mA

Colour: Red/Yellow

Dominant Wavelength (typ.): 620/590nm

Viewing angle: 120°

Materials:

FEATURES:

Die: AlGaInP-GaAs/AlGaInP-GaAs Resin: Silicone (White Diffused)

L/F Finish: Ag Plated

Operating Temperature: -40~+80°C

Storage Temperature: -40~+85°C

Grouping Parameters:

Forward voltage

Luminous intensity

Dominant Wavelength

Soldering Methods: Reflow soldering

MSL Level: acc. to JEDEC Level 3

Packing: 8mm tape with max.2000pcs/reel, ø180mm (7")

* in the order of Red/Yellow

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APPLICATIONS:

- **LED Display**
- Indicator
- Traffic Display
- **Decoration Lighting**



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	l _F	30	mA
Peak Forward Current Duty 1/8@1KHz	I _{FP}	125	mA
Reverse Voltage	V _R	5	V
Reverse Current @5V	I _R	10	μΑ
Power Dissipation	P _D	75/75	mW
Operating Temperature	T _{OPR}	-40~+80	°C
Storage Temperature	T _{STG}	-40~+85	°C

Electrical & Optical Characteristics (Ta=25°C)

Parameter	Symbol		Values		Unit	Test
Parameter	Зуппоп	Min.	Тур.	Max.	Onit	Condition
Forward Voltage	V _F	1.7/1.7*	2.0/2.0	2.5/2.5	V	I _F =20mA
Luminous Intensity	I _V	125/125	220/200	400/320	mcd	I _F =20mA
Dominant Wavelength	λ_{D}	615/585	620/590	630/595	nm	I _F =20mA
Peak Wavelength	λ_{P}		630/590		nm	I _F =20mA
Spectral Half Bandwidth	Δλ		18/17		nm	I _F =20mA
Viewing Angle	2θ _{1/2}		120		deg	I _F =20mA

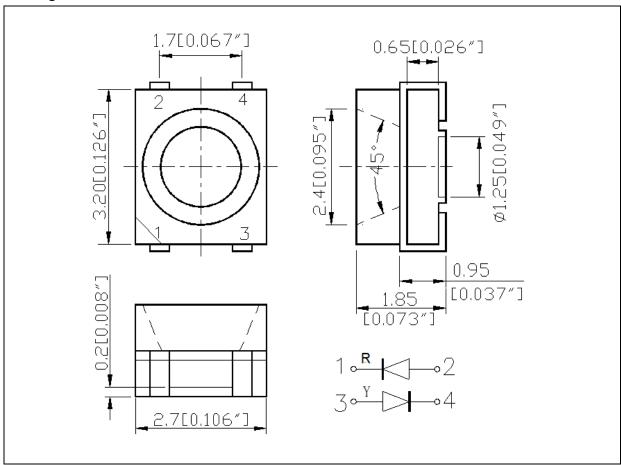
^{1.} Luminous intensity (I_V) ±15%, Forward Voltage (V_F) ±0.1V

^{2. *} in the order of Red/Yellow



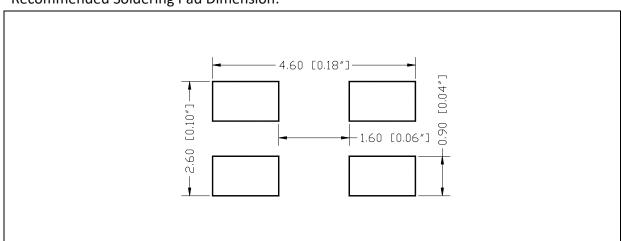
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm.



BINNING GROUPS:

Forward Voltage Classifications ($I_F = 20mA$):

Co	ode	Min. Max.		Unit
Red		1.7	2.5	V
Yellow		1.7	2.5	V

Luminous Intensity Classifications (IF = 20mA):

Co	ode	Min.	Max.	Unit
	K	125	160	mcd
	L	160	200	
Red	М	200	250	
	N	250	320	
	0	320	400	
	K	125	160	
Yellow	L	160	200	mcd
	М	200	250	
	N	250	320	

Wavelength Classifications ($I_F = 20mA$):

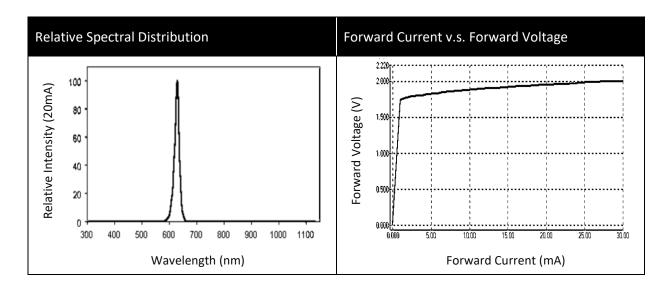
Co	de	Min.	Max.	Unit
	S	615	620	
Red	t	620	625	nm
	u	625	630	
Yellow	m	585	590	10.000
rellow	n	590	595	nm

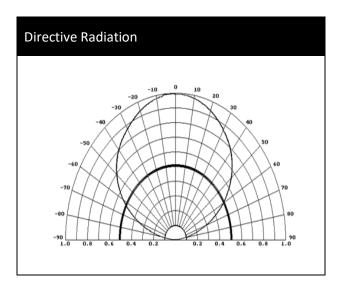
Example Group Name on Label:

• ☐Mt ☐Mm 20 = ☐ (1.7~2.5V) ► M (200~250mcd) ► t (620~625nm) ► ☐ (1.7~2.5V) ► M (200~250mcd) ► m (585~590nm) ► 20 (IF=20mA)



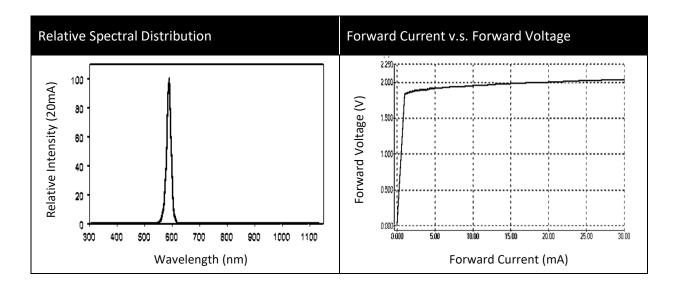
ELECTRO-OPTICAL CHARACTERISTICS (RED):

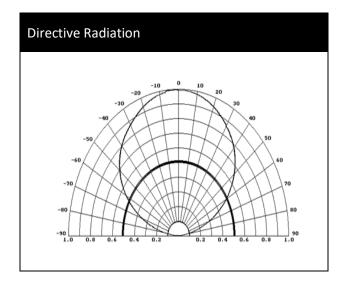






ELECTRO-OPTICAL CHARACTERISTICS (YELLOW):

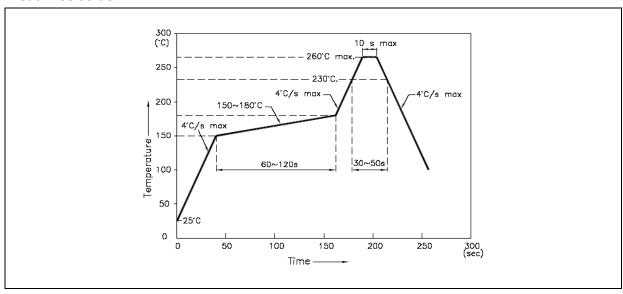






RECOMMENDED SOLDERING PROFILE:

Lead-free Solder:



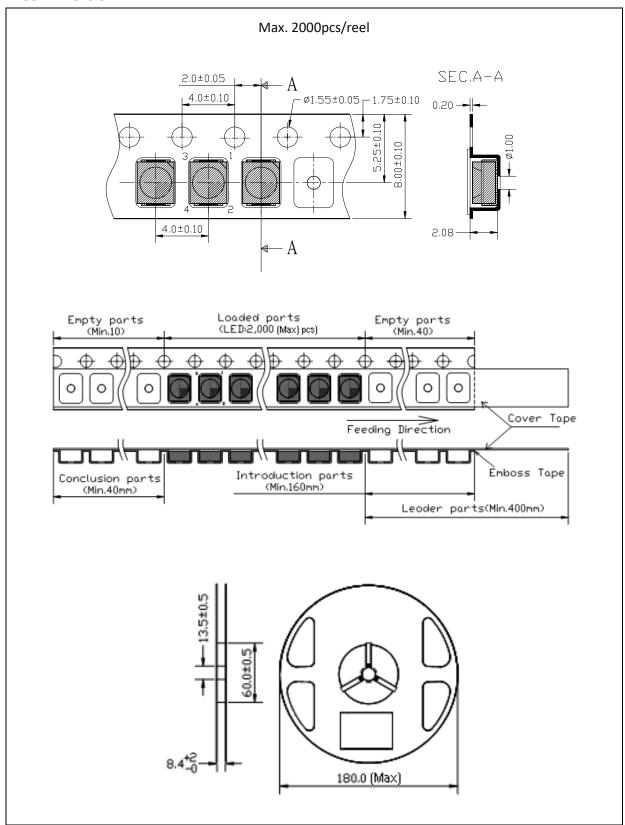
Note:

- 1. Maximum reflow soldering: 2 times.
- 2. The recommend soldering temperature is 245°C. The maximum soldering temperature should be limited to 260°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

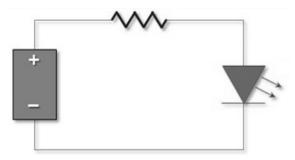
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±5°C x 36hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	25/04/2023	Datasheet set-up.